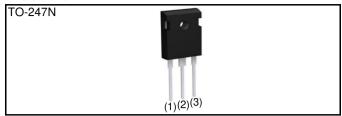


# SCT3080KL

## **N-channel SiC power MOSFET**

| $V_{\mathrm{DSS}}$           | 1200V |
|------------------------------|-------|
| R <sub>DS(on)</sub> (Typ.)   | 80mΩ  |
| I <sub>D</sub> <sup>*1</sup> | 31A   |
| $P_{D}$                      | 165W  |

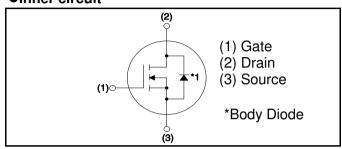
#### Outline



#### Features

- 1) Low on-resistance
- 2) Fast switching speed
- 3) Fast reverse recovery
- 4) Easy to parallel
- 5) Simple to drive
- 6) Pb-free lead plating; RoHS compliant

#### •Inner circuit



### Application

- · Solar inverters
- DC/DC converters
- Switch mode power supplies
- · Induction heating
- Motor drives

### Packaging specifications

|      | Packing                   | Tube      |
|------|---------------------------|-----------|
|      | Reel size (mm)            | -         |
| Typo | Tape width (mm)           | -         |
| Type | Basic ordering unit (pcs) | 30        |
|      | Taping code               | C11       |
|      | Marking                   | SCT3080KL |

## ● Absolute maximum ratings (T<sub>vj</sub> = 25°C unless otherwise specified)

| Parameter  |                        | Symbol                     | Value       | Unit |
|--|------------------------|----------------------------|-------------|------|
| Drain - Source Voltage                                     |                        | $V_{DSS}$                  | 1200        | V    |
| Continuous Drain current                                   | T <sub>c</sub> = 25°C  | I <sub>D</sub> *1          | 31          | Α    |
| Continuous Drain current                                   | T <sub>c</sub> = 100°C | I <sub>D</sub> *1          | 22          | Α    |
| Pulsed Drain current (T <sub>c</sub> = 25°C)               |                        | I <sub>D,pulse</sub> *2 77 |             | А    |
| Gate - Source voltage (DC)                                 |                        | $V_{GSS}$                  | -4 to +22   | V    |
| Gate - Source surge voltage (t <sub>surge</sub> < 300nsec) |                        | V <sub>GSS_surge</sub> *3  | -4 to +26   | V    |
| Recommended drive voltage                                  |                        | $V_{GS\_op}^{^{*4}}$       | 0 / +18     | V    |
| Virtual Junction temperature                               |                        | $T_{vj}$                   | 175         | °C   |
| Range of storage temperature                               |                        | T <sub>stg</sub>           | -55 to +175 | °C   |

## ullet Electrical characteristics ( $T_{vj} = 25^{\circ}C$ unless otherwise specified)

| Dorometer                                   | Symbol                 | Conditions                      | Values |      |      | Unit  |
|---|------------------------|---------------------------------|--------|------|------|-------|
| Parameter                                   | Symbol                 |                                 | Min.   | Тур. | Max. | Offit |
|   |                        | $V_{GS} = 0V$ , $I_D = 1mA$     |        |      |      |       |
| Drain - Source breakdown voltage            | $V_{(BR)DSS}$          | $T_{vj} = 25^{\circ}C$          | 1200   | -    | -    | V     |
| ronago                                      |                        | $T_{vj} = -55^{\circ}C$         | 1200   | -    | -    |       |
|   |                        | $V_{GS} = 0V, V_{DS} = 1200V$   |        |      |      |       |
| Zero Gate voltage Drain current             | I <sub>DSS</sub>       | $T_{vj} = 25^{\circ}C$          | -      | 1    | 10   | μΑ    |
| Drain current                               |                        | $T_{vj} = 150$ °C               | -      | 2    | -    |       |
| Gate - Source leakage current               | I <sub>GSS+</sub>      | $V_{GS} = +22V$ , $V_{DS} = 0V$ | -      | -    | 100  | nA    |
| Gate - Source leakage current               | I <sub>GSS-</sub>      | $V_{GS} = -4V$ , $V_{DS} = 0V$  | -      | -    | -100 | nA    |
| Gate threshold voltage                      | V <sub>GS (th)</sub>   | $V_{DS} = 10V, I_D = 5mA$       | 2.7    | ı    | 5.6  | V     |
|   |                        | $V_{GS} = 18V, I_D = 10A$       |        |      |      |       |
| Static Drain - Source on - state resistance | R <sub>DS(on)</sub> *5 | $T_{vj} = 25^{\circ}C$          | -      | 80   | 104  | mΩ    |
| on state resistance                         |                        | $T_{vj} = 150$ °C               | -      | 136  | -    |       |
| Gate input resistance                       | $R_{G}$                | f = 1MHz, open drain            | -      | 12   | -    | Ω     |

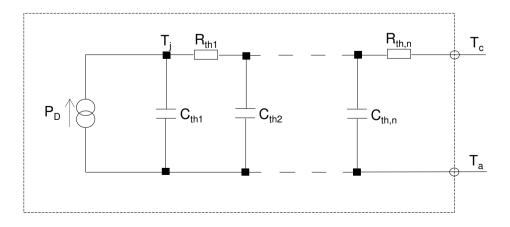
#### ●Thermal resistance

| Parameter                           | Symbol     | Values |      |      | Unit  |
|-------------------------------------|------------|--------|------|------|-------|
| raidiletei                          |            | Min.   | Тур. | Max. | Offic |
| Thermal resistance, junction - case | $R_{thJC}$ | -      | 0.70 | 0.91 | K/W   |

● Typical Transient Thermal Characteristics

| Symbol           | Value    | Unit |
|------------------|----------|------|
| R <sub>th1</sub> | 9.00E-02 |      |
| R <sub>th2</sub> | 5.96E-01 | K/W  |
| R <sub>th3</sub> | 1.47E-02 |      |

| Symbol           | Value    | Unit |
|------------------|----------|------|
| C <sub>th1</sub> | 1.23E-03 |      |
| $C_{th2}$        | 7.32E-03 | Ws/K |
| $C_{th3}$        | 1.64E-01 |      |



# ullet Electrical characteristics ( $T_{vj} = 25^{\circ}C$ unless otherwise specified)

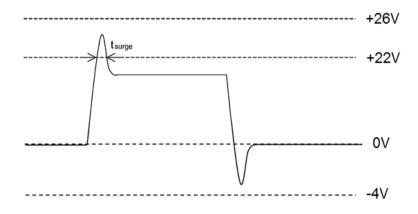
| Doromotor                                    | Symbol                 | Canditions  |      | Values |      | Unit |
|--|------------------------|---|------|--------|------|------|
| Parameter                                    | Symbol                 | Conditions  | Min. | Тур.   | Max. | Unit |
| Transconductance                             | <b>g</b> fs *5         | $V_{DS} = 10V, I_{D} = 10A$   | -    | 4.4    | -    | S    |
| Input capacitance                            | C <sub>iss</sub>       | $V_{GS} = 0V$   | -    | 785    | -    |      |
| Output capacitance                           | C <sub>oss</sub>       | V <sub>DS</sub> = 800V  | -    | 75     | -    | pF   |
| Reverse transfer capacitance                 | $C_{rss}$              | f = 1MHz  | -    | 35     | -    |      |
| Effective output capacitance, energy related | C <sub>o(er)</sub>     | $V_{GS} = 0V$ $V_{DS} = 0V \text{ to } 600V$  | -    | 74     | -    | pF   |
| Total Gate charge                            | Qg *5                  | $V_{DS} = 600V$ $I_{D} = 10A$   | -    | 60     | -    |      |
| Gate - Source charge                         | Q <sub>gs</sub> *5     | $V_{GS} = 18V$  | ı    | 11     | -    | nC   |
| Gate - Drain charge                          | Q <sub>gd</sub> *5     | See Fig. 1-1.   | -    | 31     | -    |      |
| Turn - on delay time                         | t <sub>d(on)</sub> *5  | V <sub>DS</sub> = 400V  | -    | 15     | -    |      |
| Rise time                                    | t <sub>r</sub> *5      | $I_D = 10A$ $V_{GS} = 0V/+18V$  | -    | 22     | -    |      |
| Turn - off delay time                        | t <sub>d(off)</sub> *5 | $R_G = 0\Omega$<br>$R_L = 40\Omega$   | -    | 29     | -    | ns   |
| Fall time                                    | t <sub>f</sub> *5      | See Fig. 1-1, 1-2.  | -    | 24     | -    |      |
| Turn - on switching loss                     | E <sub>on</sub> *5     | $V_{DS} = 600V$<br>$V_{GS} = 0V/18V$ , $I_D = 10A$<br>$R_G = 0\Omega$ , $L = 750\mu H$                | -    | 132    | -    | 1    |
| Turn - off switching loss                    | E <sub>off</sub> *5    | $E_{on}$ includes diode reverse recovery $L_{\sigma}$ = 50nH, $C_{\sigma}$ = 200pF See Fig. 2-1, 2-2. | -    | 18     | -    | · μJ |

## ullet Body diode electrical characteristics (Source-Drain) ( $T_{vj} = 25^{\circ}$ C unless otherwise specified)

| Parameter                              | Symbol              | Conditions  |      | Values |      |      |
|--|---------------------|---|------|--------|------|------|
| r arameter                             | Symbol              | Conditions  | Min. | Тур.   | Max. | Unit |
| Body diode continuous, forward current | I <sub>S</sub> *1   | T <sub>c</sub> = 25°C   | -    | i      | 31   | Α    |
| Body diode direct current, pulsed      | I <sub>SM</sub> *2  | 11 <sub>c</sub> = 23 0  | ı    | i      | 77   | Α    |
| Forward voltage                        | V <sub>SD</sub> *5  | $V_{GS} = 0V, I_{S} = 10A$  | -    | 3.2    | ı    | V    |
| Reverse recovery time                  | t <sub>rr</sub> *5  | $I_F = 10A$ $V_B = 600V$  | ı    | 17     | ı    | ns   |
| Reverse recovery charge                | Q <sub>rr</sub> *5  | di/dt = 1100A/µs  | ı    | 50     | ı    | nC   |
| Peak reverse recovery current          | l <sub>rrm</sub> *5 | $L_{\sigma} = 50$ nH, $C_{\sigma} = 200$ pF<br>See Fig. 3-1, 3-2. | -    | 6      | -    | Α    |

<sup>\*1</sup> Limited by maximum  $T_{vi}$  and for Max.  $R_{thJC}$ .

## \*3 Example of acceptable $V_{\text{GS}}$ waveform



\*5 Pulsed

<sup>\*2</sup> PW  $\leq$  10 $\mu$ s, Duty cycle  $\leq$  1%

 $<sup>^{\</sup>star}4$  Please be advised not to use SiC-MOSFETs with  $V_{\text{GS}}$  below 13V as doing so may cause thermal runaway.

Fig.1 Power Dissipation Derating Curve 180 160 Power Dissipation: P<sub>D</sub> [W] 140 120 100 80 60 40 20 0 25 75 125 175 Case Temperature : T<sub>C</sub> [°C]

Operation in this area is limited by  $R_{DS(on)} \equiv$ Drain Current : I<sub>D</sub> [A] 10 PW = 10µs\* PW = 100µs PW = 1ms 1 PW = 10ms  $T_c = 25^{\circ}C$ Single Pulse \*Calculation(PW≤10µs) 0.1 1000 10000 0.1 10 100 Drain - Source Voltage : V<sub>DS</sub> [V]

Fig.2 Maximum Safe Operating Area

Fig.3 Typical Transient Thermal Resistance vs. Pulse Width

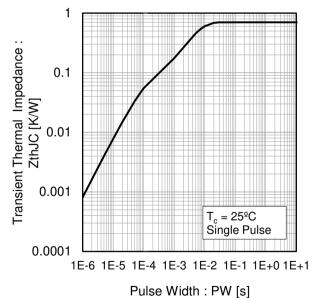


Fig.4 Typical Output Characteristics(I)

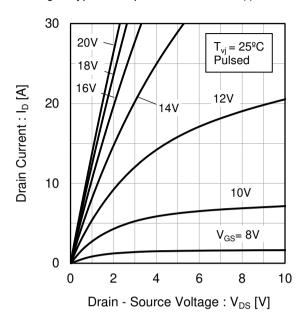


Fig.5 Typical Output Characteristics(II)

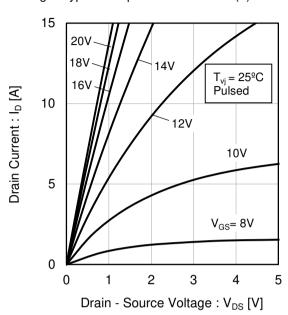
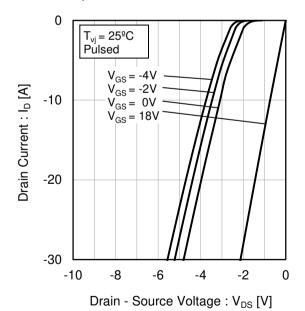
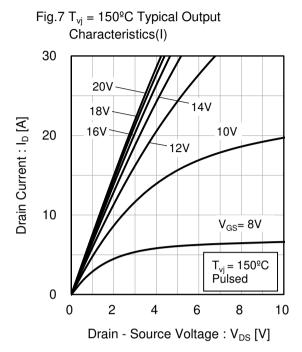


Fig.6  $T_{v_i} = 25^{\circ}C$  3rd Quadrant Characteristics





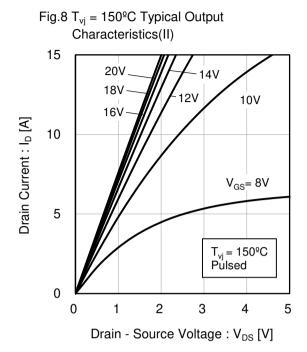


Fig.9  $T_{vj} = 150^{\circ}C$  3rd Quadrant Characteristics T<sub>vi</sub> = 150°C Pulsed  $V_{GS} = -4V$  $V_{GS} = -2V$   $V_{GS} = 0V$ Drain Current : I<sub>D</sub> [A] -10  $V_{GS}^{GS} = 18V$ -20 -30 -10 -8 -6 -2 0 Drain - Source Voltage : V<sub>DS</sub> [V]

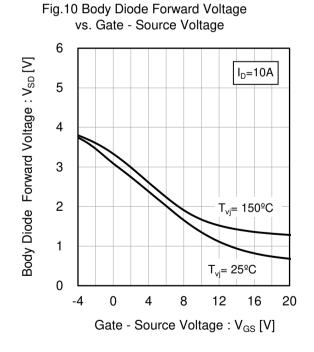


Fig.11 Typical Transfer Characteristics (I)

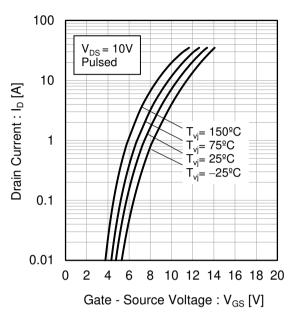


Fig.12 Typical Transfer Characteristics (II)

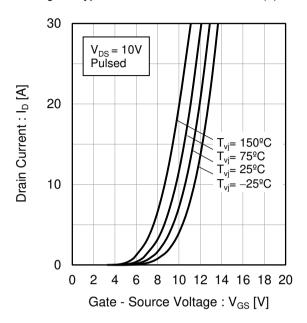


Fig.13 Gate Threshold Voltage vs. Junction Temperature

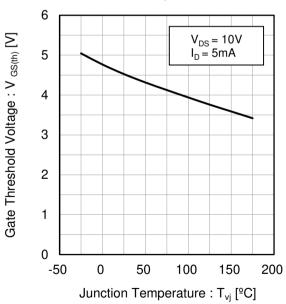
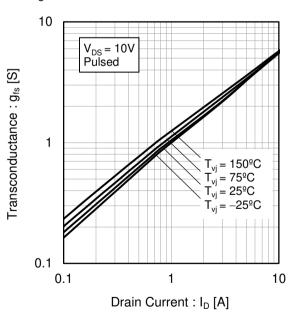


Fig.14 Transconductance vs. Drain Current



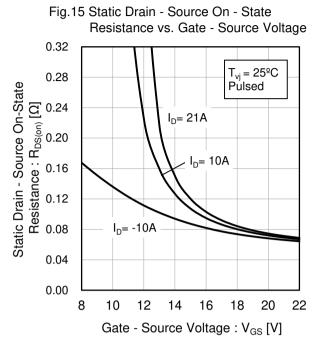


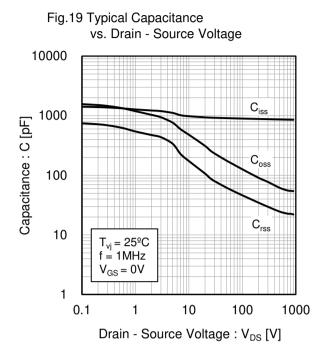
Fig.16 Static Drain - Source On - State Resistance vs. Junction Temperature 0.18  $V_{GS} = 18V$ Pulsed Static Drain - Source On-State Resistance :  $R_{DS(on)} [\Omega]$ 0.15 I<sub>D</sub>= 21A  $I_D=10A$ 0.12 -10A 0.09 0.06 0.03 0.00 -50 0 50 100 150 200 Junction Temperature : T<sub>vi</sub> [°C]

Fig.17 Static Drain - Source On - State Resistance vs. Drain Current 1 Static Drain - Source On-State Resistance:  $R_{DS(on)}$  [ $\Omega$ ] 0.1 T<sub>vj</sub> = 150ºC  $T_{vj}^{vj} = 125^{\circ}C$  $T_{vi} = 75^{\circ}C$  $T_{vj}^{\cdot,i} = 25^{\circ}C$  $V_{GS} = 18V$ T<sub>vi</sub> = −25ºC Pulsed 0.01 10 100 Drain Current: ID [A]

Voltage vs. Junction Temperature 1.04 1.03 Normalized Drain - Source Breakdown Voltage 1.02 1.01 1.00 0.99 0.98 -50 0 50 100 150 200 Junction Temperature : T<sub>vj</sub> [ºC]

ROHM

Fig.18 Normalized Drain - Source Breakdown



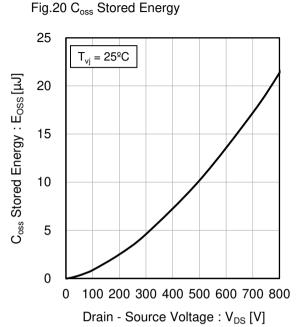
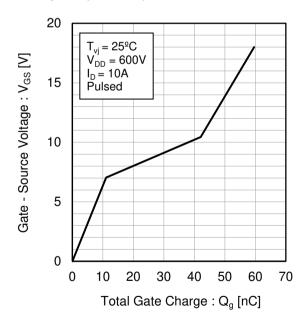
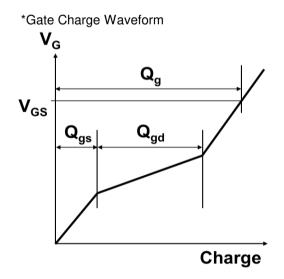


Fig.21 Dynamic Input Characteristics





1 L 0.1

#### •Electrical characteristic curves

Fig.19 Typical Switching Time

1

10

Drain Current: ID [A]

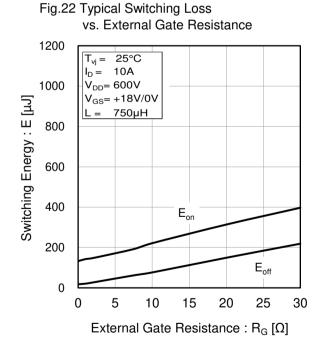
100

vs. Drain - Source Voltage 300 25°C 270 10A  $I_D =$  $V_{GS} = +18V/0V$ 240  $R_G = 0\Omega$ Switching Energy: E [µJ]  $L = 750 \mu H$ 210 180  $E_{on}$ 150 120 90 60  $\mathsf{E}_{\mathsf{off}}$ 30 O 400 200 600 800 1000

Drain - Source Voltage: V<sub>DS</sub> [V]

Fig.20 Typical Switching Loss

Fig.21 Typical Switching Loss vs. Drain Current 1200 25°C V<sub>DD</sub>= 600V 1000  $V_{GS} = +18V/0V$ Switching Energy : E [µJ]  $R_G = 0\Omega$ 750µH 800 600 400  $\mathsf{E}_{\mathsf{on}}$ 200 Eoff 0 5 10 15 25 0 20 30 Drain Current : I<sub>D</sub> [A]



#### Measurement circuits and waveforms

Fig.1-1 Gate Charge and Switching Time Measurement Circuit

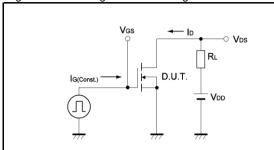


Fig.2-1 Switching Energy Measurement Circuit

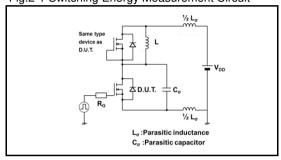


Fig.3-1 Reverse Recovery Time Measurement Circuit

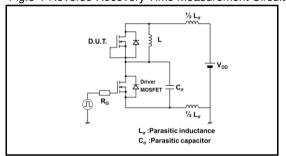


Fig.1-2 Waveforms for Switching Time

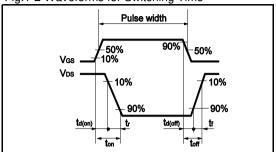


Fig.2-2 Waveforms for Switching Energy Loss

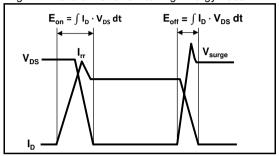
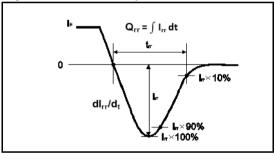
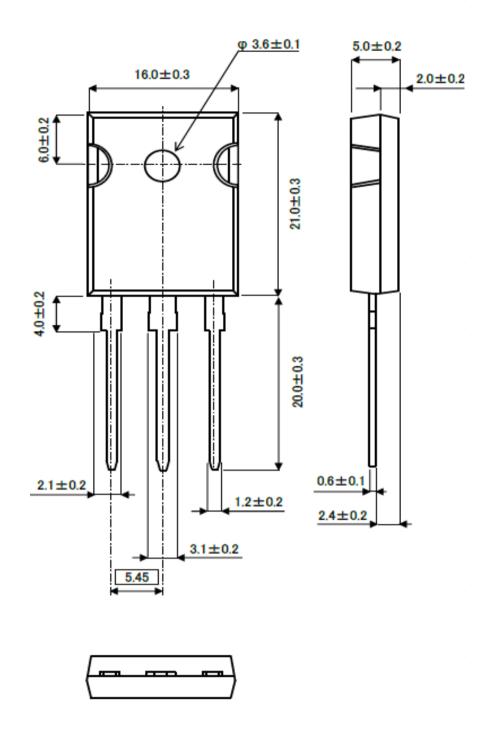


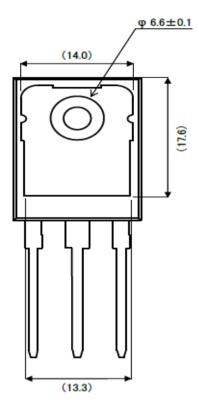
Fig.3-2 Reverse Recovery Waveform



## ●Package Dimensions

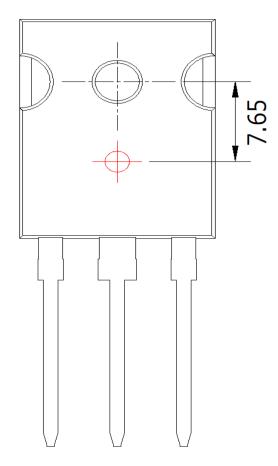


Unit: mm



Unit: mm

## ●Die Bonding Layout





- •Front view of the packaging.
- •Dimensions are design values.
- ·If the heat sink is to be installed, it should be in contact with the die bonding point.

Unit: mm

#### Notes

- 1) The information contained herein is subject to change without notice.
- Before you use our Products, please contact our sales representative and verify the latest specifications
- 3) Although ROHM is continuously working to improve product reliability and quality, semiconductors can break down and malfunction due to various factors.

  Therefore, in order to prevent personal injury or fire arising from failure, please take safety measures such as complying with the derating characteristics, implementing redundant and fire prevention designs, and utilizing backups and fail-safe procedures. ROHM shall have no responsibility for any damages arising out of the use of our Poducts beyond the rating specified by ROHM.
- 4) Examples of application circuits, circuit constants and any other information contained herein are provided only to illustrate the standard usage and operations of the Products. The peripheral conditions must be taken into account when designing circuits for mass production.
- 5) The technical information specified herein is intended only to show the typical functions of and examples of application circuits for the Products. ROHM does not grant you, explicitly or implicitly, any license to use or exercise intellectual property or other rights held by ROHM or any other parties. ROHM shall have no responsibility whatsoever for any dispute arising out of the use of such technical information.
- 6) The Products specified in this document are not designed to be radiation tolerant.
- 7) For use of our Products in applications requiring a high degree of reliability (as exemplified below), please contact and consult with a ROHM representative: transportation equipment (i.e. cars, ships, trains), primary communication equipment, traffic lights, fire/crime prevention, safety equipment, medical systems, and power transmission systems.
- 8) Do not use our Products in applications requiring extremely high reliability, such as aerospace equipment, nuclear power control systems, and submarine repeaters.
- 9) ROHM shall have no responsibility for any damages or injury arising from non-compliance with the recommended usage conditions and specifications contained herein.
- 10) ROHM has used reasonable care to ensure the accuracy of the information contained in this document. However, ROHM does not warrants that such information is error-free, and ROHM shall have no responsibility for any damages arising from any inaccuracy or misprint of such information.
- 11) Please use the Products in accordance with any applicable environmental laws and regulations, such as the RoHS Directive. For more details, including RoHS compatibility, please contact a ROHM sales office. ROHM shall have no responsibility for any damages or losses resulting non-compliance with any applicable laws or regulations.
- 12) When providing our Products and technologies contained in this document to other countries, you must abide by the procedures and provisions stipulated in all applicable export laws and regulations, including without limitation the US Export Administration Regulations and the Foreign Exchange and Foreign Trade Act.
- 13) This document, in part or in whole, may not be reprinted or reproduced without prior consent of ROHM.



Thank you for your accessing to ROHM product informations. More detail product informations and catalogs are available, please contact us.

## ROHM Customer Support System

http://www.rohm.com/contact/

#### **General Precaution**

- 1. Before you use our Products, you are requested to carefully read this document and fully understand its contents. ROHM shall not be in any way responsible or liable for failure, malfunction or accident arising from the use of any ROHM's Products against warning, caution or note contained in this document.
- 2. All information contained in this document is current as of the issuing date and subject to change without any prior notice. Before purchasing or using ROHM's Products, please confirm the latest information with a ROHM sales representative.
- 3. The information contained in this document is provided on an "as is" basis and ROHM does not warrant that all information contained in this document is accurate and/or error-free. ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties resulting from inaccuracy or errors of or concerning such information.

Notice – WE Rev.001